



#7/1-24-01  
Docket No.: M4065.0226/P226  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Tongbi Jiang

Application No.: 09/484,437

Group Art Unit: 2822

Filed: January 18, 2000

Examiner: James M. Mitchell

For: DIE ATTACH CURING METHOD FOR  
BGA PRODUCT

SUBMISSION OF FORMAL DRAWINGS

Commissioner for Patents  
Washington, DC 20231

Dear Sir:

Submitted herewith is one set (five sheets, 1-7 figures) of formal drawings for filing in the above-identified patent application. Kindly substitute the enclosed formal drawings for the informal drawings submitted with the originally filed application.

Dated: December 21, 2001

Respectfully submitted,

By 

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